UNRF1A0

Silicon PNP epitaxial planar transistor

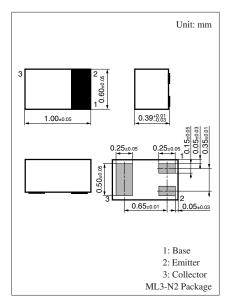
For digital circuits

Features

• Suitable for high-density mounting and downsizing of the equipment for Ultraminiature leadless package 0.6 mm × 1.0 mm (height 0.39 mm)

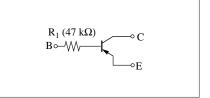
| Parameter | Symbol | Rating | Unit | | | | | |
|---------------------------------------|------------------|-------------|------|--|--|--|--|--|
| Collector-base voltage (Emitter open) | V _{CBO} | -50 | V | | | | | |
| Collector-emitter voltage (Base open) | V _{CEO} | -50 | V | | | | | |
| Collector current | I _C | -80 | mA | | | | | |
| Total power dissipation | P _T | 100 | mW | | | | | |
| Junction temperature | Tj | 125 | °C | | | | | |
| Storage temperature | T _{stg} | -55 to +125 | °C | | | | | |

Absolute Maximum Ratings $T_a = 25^{\circ}C$



Marking Symbol: 1R

Internal Connection

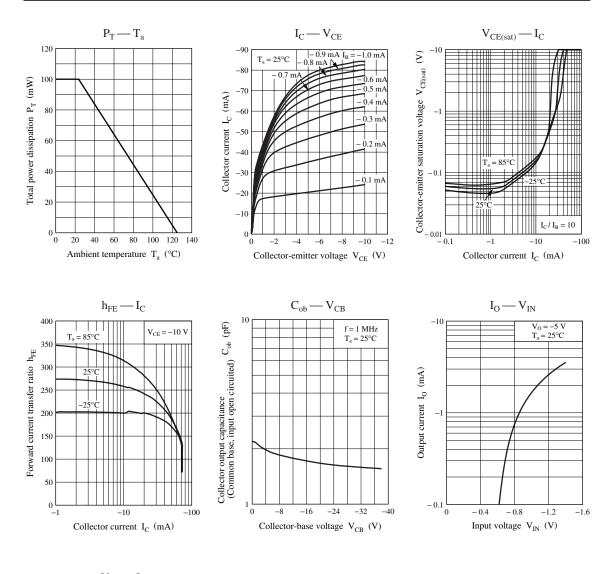


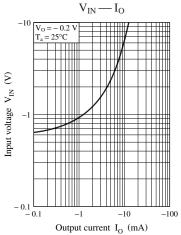
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|----------------------|--|------|-----|--------|------|
| Collector-base voltage (Emitter open) | V _{CBO} | $I_{C} = -10 \ \mu A, \ I_{E} = 0$ | -50 | | | V |
| Collector-emitter voltage (Base open) | V _{CEO} | $I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$ | -50 | | | V |
| Collector-base cutoff current (Emitter open) | I _{CBO} | $V_{CB} = -50 \text{ V}, I_E = 0$ | | | - 0.1 | μΑ |
| Collector-emitter cutoff current (Base open) | I _{CEO} | $V_{CE} = -50 \text{ V}, I_B = 0$ | | | - 0.5 | μΑ |
| Emitter-base cutoff current (Collector open) | I _{EBO} | $V_{EB} = -6 V, I_C = 0$ | | | - 0.1 | mA |
| Forward current transfer ratio | h _{FE} | $V_{CE} = -10 \text{ V}, I_C = -5 \text{ mA}$ | 160 | | 460 | _ |
| Collector-emitter saturation voltage | V _{CE(sat)} | $I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -0.3 \text{ mA}$ | | | - 0.25 | V |
| Output voltage high level | V _{OH} | $V_{CC} = -5 \text{ V}, V_B = -0.5 \text{ V}, R_L = 1 \text{ k}\Omega$ | -4.9 | | | V |
| Output voltage low level | V _{OL} | $V_{CC} = -5 \text{ V}, \text{V}_{\text{B}} = -2.5 \text{V}, \text{R}_{\text{L}} = 1 \text{k}\Omega$ | | | - 0.2 | V |
| Input resistance | R ₁ | | -30% | 47 | +30% | kΩ |
| Transition frequency | f _T | $V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$ | | 80 | | MHz |

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

Panasonic





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